

QSFP28 100GBASE-CWDM4 1310nm 2km Transceiver

DEM-Q28X02Q-IR4-LL



Application

- 100G Ethernet Links
- Infiniband EDR
- Data Center Interconnect
- · Enterprise networking

Features

- QSFP28 MSA compliant
- 4 CWDM lanes MUX/DEMUX design
- Supports 103.1Gb/s aggregate bit rate
- RoHS compliant

- Operating case temperature: 0 to 70°C
- 100G CWDM4 MSA Technical Spec Rev1.1
- Up to 2km transmission on single mode fiber (SMF) with FEC
- LC duplex connector
- Maximum power consumption 3.5W
- 4x25G electrical interface (OIF CEI-28G-VSR)



Description

I. General Description

This product is a transceiver module designed for 2km optical communication applications. The design is compliant to 1000GBASE CWDM4 MSA standard. The module converts 4 inputs channels (ch) of 25Gb/s electrical data to 4 CWDM optical signals, and multiplexes them into a single channel for 100Gb/s optical transmission. Reversely, on the receiver side, the module optically de-multiplexes a 100Gb/s input into 4 CWDM channels signals, and converts them to 4 channel output electrical data.

The central wavelengths of the 4 CWDM channels are 1271, 1291, 1311 and 1331 nm as members of the CWDM wavelength grid defined in ITU-T G.694.2. It contains a duplex LC connector for the optical interface and a 38-pin connector for the electrical interface. To minimize the optical dispersion in the long-haul system, single-mode fiber (SMF) has to be applied in this module. Host FEC is required to support up to 2km fiber transmission.

The product is designed with form factor, optical/electrical connection and digital diagnostic interface according to the QSFP28 Multi-Source Agreement (MSA). It has been designed to meet the harshest external operating conditions including temperature, humidity and EMI interference.

II. Functional Description

This product converts the 4-channel 100Gb/s electrical input data into CWDM optical signals (light), by a driven 4-wavelength Distributed Feedback Laser (DFB) array. The light is combined by the MUX parts as a 100Gb/s data, propagating out of the transmitter module from the SMF. The receiver module accepts the 100Gb/s CWDM optical signals input, and de-multiplexes it into 4 individual 25Gb/s channels with different wavelength. Each wavelength light is collected by a discrete photo diode, and then outputted as electric data after amplified by a TIA and a post amplifier. Figure 1 shows the functional block diagram of this product.

A single +3.3V power supply is required to power up this product. Both power supply pins VccTx and VccRx are internally connected and should be applied concurrently. As per MSA specifications the module offers 7 low speed hardware control pins (including the 2-wire serial interface): ModSelL, SCL, SDA, ResetL, LPMode, ModPrsL and IntL.

Module Select (ModSelL) is an input pin. When held low by the host, this product responds to 2-wire serial communication commands. The ModSelL allows the use of this product on a single 2-wire interface bus – individual ModSelL lines must be used.

Serial Clock (SCL) and Serial Data (SDA) are required for the 2-wire serial bus communication interface and enable the host to access the QSFP+ memory map.

The ResetL pin enables a complete reset, returning the settings to their default state, when a low level on the ResetL pin is held for longer than the minimum pulse length. During the execution of a reset the host shall disregard all status bits until it indicates a completion of the reset interrupt. The product indicates this by posting an IntL (Interrupt) signal with the Data Not Ready bit negated in the memory map. Note that on power up (including hot insertion) the module should post this completion of reset interrupt without requiring a reset.

Low Power Mode (LPMode) pin is used to set the maximum power consumption for the product in order to protect hosts that are not capable of cooling higher power modules, should such modules be accidentally inserted.



Module Present (ModPrsL) is a signal local to the host board which, in the absence of a product, is normally pulled up to the host Vcc. When the product is inserted into the connector, it completes the path to ground through a resistor on the host board and asserts the signal. ModPrsL then indicates its present by setting ModPrsL to a "Low" state.

Interrupt (IntL) is an output pin. "Low" indicates a possible operational fault or a status critical to the host system. The host identifies the source of the interrupt using the 2-wire serial interface. The IntL pin is an open collector output and must be pulled to the Host Vcc voltage on the Host board.

Product Specifications

I. Absolute Maximum Ratings

| Parameter | Symbol | Min | Max | Unit | Notes |
|--------------------------------------|--------|------|-----|------|-------|
| Storage Temperature | TS | -40 | 85 | degC | |
| Operating Case Temperature | ТОР | 0 | 70 | degC | |
| Power Supply Voltage | VCC | -0.5 | 3.6 | V | |
| Relative Humidity (non-condensation) | RH | 0 | 85 | % | |
| Damage Threshold, each Lane | THd | 3.5 | | dBm | |

II. Recommended Operating Conditions and Power Supply Requirements

| Parameter | Symbol | Min | Тур. | Max | Unit |
|----------------------------|--------|-------|----------|-------|------|
| Operating Case Temperature | TOP | 0 | | 70 | degC |
| Power Supply Voltage | VCC | 3.135 | 3.3 | 3.465 | V |
| Data Rate, each Lane | | | 25.78125 | | Gb/s |
| Data Rate Accuracy | | -100 | | 100 | ppm |
| Control Input Voltage High | | 2 | | Vcc | V |
| Control Input Voltage Low | | 0 | | 0.8 | V |
| Link Distance with G.652 | D | 0.002 | | 2 | km |



III. Electrical Characteristics

| Parameter | Test Point | Min | Тур. | Max | Unit | Notes |
|--|------------|--|-------|---------------------------------------|------|---------|
| Power Consumption | | | | 3.5 | W | |
| Supply Current | lcc | | | 1.06 | Α | |
| | Transm | itter (each L | .ane) | | | |
| Overload Differential Voltage pk-pk | TP1a | 900 | | | mV | |
| Common Mode Voltage (Vcm) | TP1 | -350 | | 2850 | mV | 1 |
| Differential Termination Resistance Mismatch | TP1 | | | 10 | % | At 1MHz |
| Differential Return Loss (SDD11) | TP1 | | | See CEI- 28G- VSREquation 13-19 | dB | |
| Common Mode to Differential conversion and Differential to Common Mode conversion (SDC11, SCD11) | TP1 | | | See CEI- 28G- VSREquation 13-20 | dB | |
| Stressed Input Test | TP1a | See CEI- 28G- VSRSection13. 3.11.2.1 | | | | |
| | Recei | ver(each La | ne) | | | |
| Differential Voltage, pk-pk | TP4 | | | 900 | mV | |
| Common Mode Voltage (Vcm) | TP4 | -350 |) | 2850 | mV | 1 |
| Common Mode Noise, RMS | TP4 | | | 17.5 | mV | |
| Differential Termination Resistance Mismatch | TP4 | | | 10 | % | At 1MHz |
| Differential Return Loss (SDD22) | TP4 | | | See CEI- 28G VSREquation 13-19 | | |



| Parameter | Symbol | Min | Тур. | Max | Unit | Ref. |
|--|--------|------|------|---------------------------------------|------|------|
| Common Mode to Differential conversion and Differential to Common Mode conversion (SDC22, SCD22) | TP4 | | | See CEI- 28G- VSREquation 13-21 | dB | |
| Common Mode Return Loss (SCC22) | TP4 | | | -2 | dB | 1 |
| Transition Time, 20 to 80% | TP4 | 9.5 | | | ps | |
| Vertical Eye Closure (VEC) | TP4 | | | 5.5 | dB | |
| Eye Width at 10 ⁻¹⁵ probability (EW15) | TP4 | 0.57 | | | UI | |
| Eye Height at 10 ⁻¹⁵ probability (EH15) | TP4 | 228 | | | mV | |

Notes:

1.Vcm is generated by the host. Specification includes effects of ground offset voltage.

IV. Optical Characteristics

| Parameter | Symbol | Min | Тур. | Max | Unit | Notes |
|-----------------------|--------|--------|------|--------|------|-------|
| | LO | 1264.5 | 1271 | 1277.5 | nm | |
| Wayslangth Assignment | L1 | 1284.5 | 1291 | 1297.5 | nm | |
| Wavelength Assignment | L2 | 1304.5 | 1311 | 1317.5 | nm | |
| | L3 | 1324.5 | 1331 | 1337.5 | nm | |

Transmitter

| Side Mode Suppression Ratio | SMSR | 30 | | dB | |
|---------------------------------|-----------|------|-----|-----|--|
| Total Average Launch Power | P_T | | 8.5 | dBm | |
| Average Launch Power, each Lane | P_{AVG} | -6.5 | 2.5 | dBm | |

^{2.}From 250MHz to 30GHz.



| Parameter | Symbol | Min | Тур. | Max | Unit | Notes |
|---|--------|----------|----------------------|---------|-------|--------------------|
| Optical Modulation Amplitude (OMA), each Lane | POMA | -4 | | 2.5 | dBm | 1 |
| Launch Power in OMA minus Transmitter and Dispersion Penalty (TDP), each Lane | | -5 | | | dBm | |
| TDP, each Lane | TDP | | | 3.0 | dB | |
| Extinction Ratio | ER | 3.5 | | | dB | |
| Relative Intensity Noise | RIN | | | -130 | dB/Hz | 12dB reflection |
| Optical Return Loss Tolerance | TOL | | | 20 | dB | |
| Transmitter Reflectance | RT | | | -12 | dB | |
| Average Launch Power OFF Transmitter, each Lane | Poff | | | -30 | dBm | |
| Transmitter Eye Mask Definition {X1, X2, X3, Y1, Y2, Y3} | | {0.31, (| 0.4, 0.45, 0.34, 0.3 | 8, 0.4} | | |
| | Re | eceiver | | | | |
| Damage Threshold, each Lane | THd | 3.5 | | | dBm | 3 |
| Total Average Receive Power | | | | 8.5 | dBm | |
| Average Receive Power, each Lane | | -11.5 | | 2.5 | dBm | |
| Receive Power (OMA), each Lane | | | | 2.5 | dBm | |
| Receiver Sensitivity (OMA), each Lane | SEN | | | -10 | dBm | for BER = 5x10-5 |



| Parameter | Symbol | Min | Тур. | Max | Unit | Notes |
|---|--------|-----|------|------|------|-------|
| Stressed Receiver Sensitivity (OMA), each Lane | | | | -7.3 | dBm | 4 |
| Receiver Reflectance | RR | | | -26 | dB | |
| LOS Assert | LOSA | -30 | | | dBm | |
| LOS Deassert | LOSD | | | -12 | dBm | |
| LOS Hysteresis | LOSH | 0.5 | | | dB | |
| Receiver Electrical 3 dB upper Cutoff Frequency, each Lane | | | | 31 | GHz | |

Conditions of Stress Receiver Sensitivity Test (Note 5)

| Vertical Eye Closure Penalty, each Lane | 1.9 | dB |
|---|------|----|
| Stressed Eye J2 Jitter, each Lane | 0.33 | UI |
| Stressed Eye J4 Jitter, each Lane | 0.48 | UI |
| | | |

SRS eye mask definition { X1, X2, X3, Y1, Y2, Y3}

 $\{0.39,\,0.5,\,0.5,\,0.39,\,0.39,\,0.4\}$

dB

Notes:

- 1. Even if the TDP < 1.0 dB, the OMA min must exceed the minimum value specified here.
- 2. Hit ratio 5x10-5.
- 3. The receiver shall be able to tolerate, without damage, continuous exposure to a modulated optical input signal having this power level on one lane. The receiver does not have to operate correctly at this input power.
- 4. Measured with conformance test signal for BER = 5x10-5.
- 5. Vertical eye closure penalty, stressed eye J2 jitter, stressed eye J4 jitter, and SRS eye mask definition are test conditions for measuring stressed receiver sensitivity. They are not characteristics of the receiver.



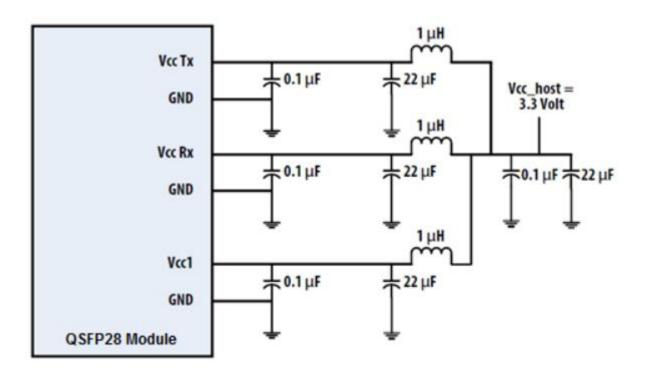
V. Digital Diagnostic Functions

| Parameter | Symbol | Min | Max | Unit | Notes |
|--|--------------|------|-----|------|----------------------------------|
| Temperature monitor absolute error | DMI_Temp | -3 | 3 | degC | Over operating temperature range |
| Supply voltage monitor absolute error | DMI_VCC | -0.1 | 0.1 | V | Over full operating range |
| Channel RX power monitor absolute error | DMI_RX_Ch | -2 | 2 | dB | 1 |
| Channel Bias current monitor | DMI_Ibias_Ch | -10% | 10% | mA | |
| Channel TX power monitor absolute error | DMI_TX_Ch | -2 | 2 | dB | 1 |

Notes:

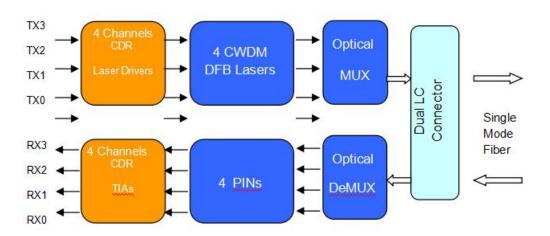
1. Due to measurement accuracy of different single mode fibers, there could be an additional +/-1 dB fluctuation, or a +/- 3 dB total accuracy.

VI. Recommended Power Supply Filter

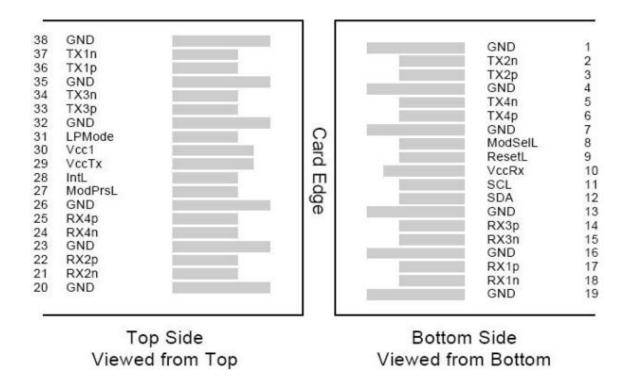




VII. Transceiver Block Diagram



VIII. Pin Assignment and Description





| Pin | Logic | Symbol | Name/Description | Notes |
|-----|------------|---------|--------------------------------------|-------|
| 1 | | GND | Ground | 1 |
| 2 | CML-I | Tx2n | Transmitter Inverted Data Input | |
| 3 | CML-I | Tx2p | Transmitter Non-Inverted Data output | |
| 4 | | GND | Ground | 1 |
| 5 | CML-I | Tx4n | Transmitter Inverted Data Input | |
| 6 | CML-I | Tx4p | Transmitter Non-Inverted Data output | |
| 7 | | GND | Ground | 1 |
| 8 | LVTLL-I | ModSelL | Module Select | |
| 9 | LVTLL-I | ResetL | Module Reset | |
| 10 | | VccRx | +3.3V Power Supply Receiver | 2 |
| 11 | LVCMOS-I/O | SCL | 2-Wire Serial Interface Clock | |
| 12 | LVCMOS-I/O | SDA | 2-Wire Serial Interface Data | |
| 13 | | GND | Ground | |
| 14 | CML-O | Rx3p | Receiver Non-Inverted Data Output | |
| 15 | CML-O | Rx3n | Receiver Inverted Data Output | |
| 16 | | GND | Ground | 1 |
| 17 | CML-O | Rx1p | Receiver Non-Inverted Data Output | |
| 18 | CML-O | Rx1n | Receiver Inverted Data Output | |
| 19 | | GND | Ground | 1 |
| 20 | | GND | Ground | 1 |



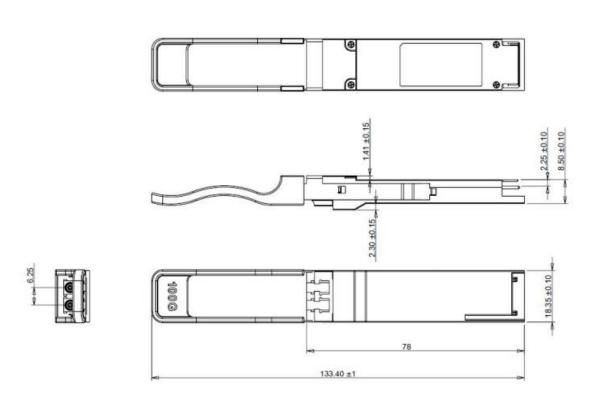
| Pin | Logic | Symbol | Name/Description | Ref. |
|-----|---------|---------|-------------------------------------|------|
| 21 | CML-O | Rx2n | Receiver Inverted Data Output | |
| 22 | CML-O | Rx2p | Receiver Non-Inverted Data Output | |
| 23 | | GND | Ground | 1 |
| 24 | CML-O | Rx4n | Receiver Inverted Data Output | 1 |
| 25 | CML-O | Rx4p | Receiver Non-Inverted Data Output | |
| 26 | | GND | Ground | 1 |
| 27 | LVTTL-O | ModPrsL | Module Present | |
| 28 | LVTTL-O | IntL | Interrupt | |
| 29 | | VccTx | +3.3 V Power Supply transmitter | 2 |
| 30 | | Vcc1 | +3.3 V Power Supply | 2 |
| 31 | LVTTL-I | LPMode | Low Power Mode | |
| 32 | | GND | Ground | 1 |
| 33 | CML-I | Tx3p | Transmitter Non-Inverted Data Input | |
| 34 | CML-I | Tx3n | Transmitter Inverted Data Output | |
| 35 | | GND | Ground | 1 |
| 36 | CML-I | Tx1p | Transmitter Non-Inverted Data Input | |
| 37 | CML-I | Tx1n | Transmitter Inverted Data Output | |
| 38 | | GND | Ground | 1 |



Notes:

- 1.GND is the symbol for signal and supply (power) common for QSFP28 modules. All are common within the QSFP28 module and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal common ground plane.
- 2. VccRx, Vcc1 and VccTx are the receiving and transmission power suppliers and shall be applied concurrently. Recommended host board power supply filtering is shown in Figure 3 below. Vcc Rx, Vcc1 and Vcc Tx may be internally connected within the QSFP28 transceiver module in any combination. The connector pins are each rated for a maximum current of 1000mA.

IX. Mechanical Specifications



X. ESD

This transceiver is specified as ESD threshold 1kV for SFI pins and 2kV for all other electrical input pins, tested per MIL-STD-883, Method 3015.4 /JESD22-A114-A (HBM). However, normal ESD precautions are still required during the handling of this module. This transceiver is shipped in ESD protective packaging. It should be removed from the packaging and handled only in an ESD protected environment.

XI. Laser Safety

This is a Class 1 Laser Product according to EN 60825-1:2014. This product complies with 21 CFR 1040.10 and 1040.11 except for deviations pursuant to Laser Notice No. 50, dated (June 24, 2007).

Caution: Use of controls or adjustments or performance of procedures other than those specified herein may result in hazardous radiation exposure.